### **UBR Series**

#### **Ultra-Broadband Resistors**







#### **GENERAL DESCRIPTION**

AVX Passive Micro Component group is pleased to introduce the UBR Series of next generation of surface mount Ultra-Broadband Resistors. This product was designed utilizing our proprietary Glass Sandwich Flexiterm® Technology, (GSFT). The Flexiterm® is a surface mountable automotive qualified termination that adds an extra margin against damage due to flexture during installation.

The UBR Series has been designed with high quality selected materials that yield excellent performance. This product is ideal for use in Optical Transceiver Modules or any application requiring excellent ultra-broadband performance. The use of glass sandwich technology and precision laser triming reduces parasitic noise up to 40 GHz.

#### **FEATURES**

- Frequency Range: DC to 40 GHz
- EIA 0402 Case Size
- Power Rating: 125 mW
- Operating Temperature: -40°C to +125°C
- 100% Laser Trimming for Tight Tolerances
- RoHS Compliant

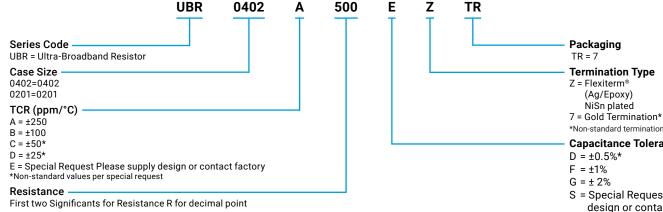
#### **APPLICATIONS**

- · Optical Transceiver Modules
- **Broadband Receiver**
- TOSA / ROSA
- Wideband Test Equipment
- Low Noise Amplifier
- **MMIC Amplifiers**
- Mixers
- **Directional Couplers**
- · Ultra-Broadband Splitters and Combiners

#### **MARKETS**

- Opto-electronics
- Automotive
- Telecom
- **Broadband Jamming for EW**
- Satellite Communication

#### **HOW TO ORDER**



\*Non-standard termination per special request Capacitance Tolerance

S = Special Request Please supply design or contact factory

\*Non-Standard tolerance values per special request



\*Data files contain DXF, S2P, and HFSS files





For RoHS compliant products, please select correct termination style



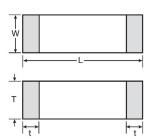
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#### **Ultra-Broadband Resistors**





#### **MECHANICAL DIMENSIONS**



Length	1.00±0.10		
(L)	(0.039±0.004)		
Width	0.50±0.10		
(W)	(0.020±0.004)		
Thickness	0.50±0.10		
(T)	(0.020±0.004)		
Terminal	0.25±0.15		
(t)	(0.010±0.006)		

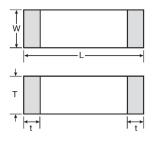
# 0402 SPECIFICATIONS Resistor

Resistor	Detail	
Outline	EIA 0402	
Package	Glass wafer sandwich	
Maximum Voltage	1 KV	
Resistance Value Range	From 16.6 Ohms to 200 Ohms	
Termination	FLEXITERM® (Ag/Epoxy), plated	
Power Rating	125 mW	
Operating Temperature Range	-40°C to +125°C	
Tolerances	0.5%, 1%, 2%, 5%	

#### **MECHANICAL DIMENSIONS**

mm (inches)

mm (inches)

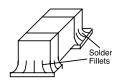


Length	0.60±0.050		
(L)	(0.024±0.010)		
Width	0.325±0.050		
(W)	(0.024±0.010)		
<b>Thickness</b> 0.325±0.050			
(T)	(0.020±0.004)		
Terminal	0.150±0.050		
(t)	(0.006±0.010)		

#### **0201 SPECIFICATIONS**

Resistor	Detail	
Outline	EIA 0201	
Package	Glass wafer sandwich	
Maximum Voltage	1 KV	
Resistance Value Range	From 16.6 Ohms to 200 Ohms	
Termination	FLEXITERM® (Ag/Epoxy), plated	
Power Rating	125 mW	
Operating Temperature Range	-40°C to +125°C	
Tolerances	0.5%, 1%, 2%, 5%	

#### SUGGESTED MOUNTING PAD DIMENSIONS



**Normal Pads** 

W = Chip Width L = Chip Length T = Chip Thickness

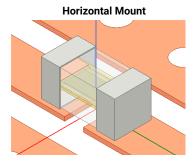
	<b>⊢</b> в →		<b>←</b> B →
1			
Α		— c —	
	<b>——</b>	– D —	

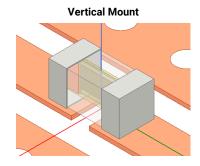
Case Size	A Min.	B Min.	C Min.	D Min.
0201	0.0256	0.0075	0.0130	0.0268
0402	0.0213	0.0125	0.0206	0.0436

Dimensions are in inches.

#### NOTES:

Mounting will allow the solder fillet to travel up approximately 0.015" of the chip's end and side termination surface. Heavier fillets require a predeposition of solder paste and or an increase in pad dimensions. Typical solder paste application is a .008" to 0.01" thickness with >50% of volume in solder alloy. Can be mounted in both vertical and horizontal orientation without changing electrical performance





# 单击下面可查看定价,库存,交付和生命周期等信息

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